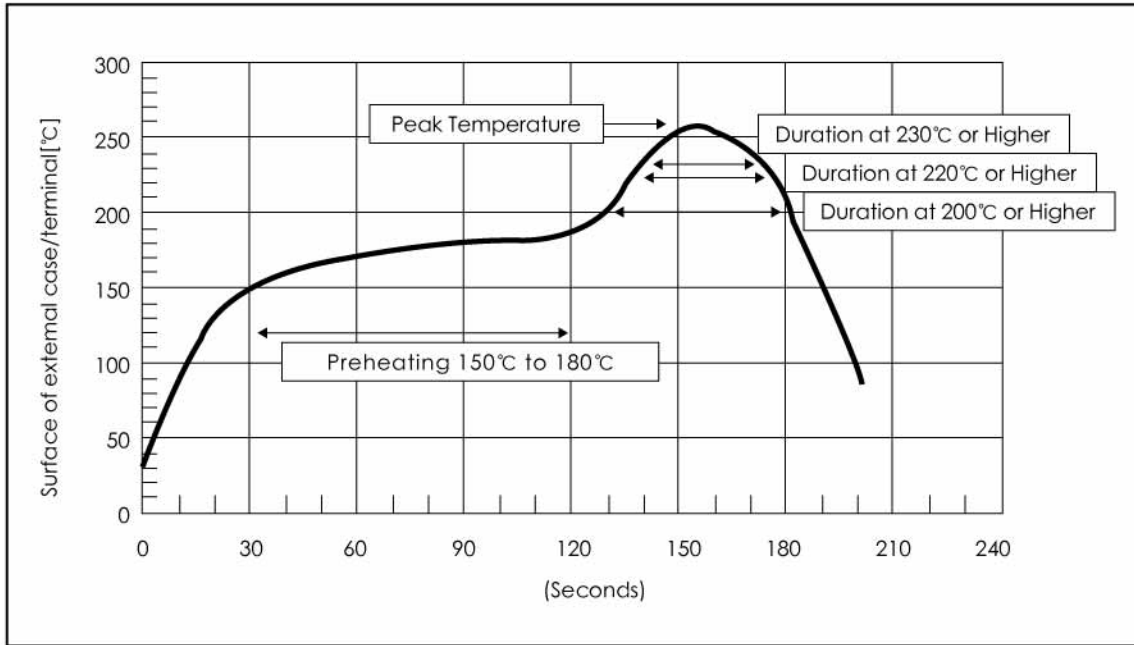




Reflow Soldering



Item \ Series	HVC、HVM	
Peak temperature (MAX)	250°C	260°C
Preheat	150°C to 180°C 90 ± 30 sec	
200°C over time (MAX)	60sec	60sec
220°C over time (MAX)	50sec	50sec
230°C over time (MAX)	40sec	40sec
Reflow number	Twice or less	Only 1 time

In regards to flow soldering, be sure to solder within the following conditions.

	Temperature	Duration
Preheating	120°C or less (ambient temperature)	120 sec. or less
Soldering conditions	260+5°C or less	10 sec. or less

The moisture absorption level of the SMD type is shown below after open the packing

LEVEL	Floor life	
	Time	Condition
2a	4Week	≤30°C/60%RH